

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TETSURO NISHIMURA	05/20/2016
YUTAKA FUKUSHIMA	05/20/2016
HIDEKI YOSHIDA	05/20/2016
RECEIVING PARTY DATA	
Name:	NIHON SUPERIOR CO., LTD.
Street Address:	1-16-15, ESAKACHO, SUITA-SHI
City:	OSAKA
State/Country:	JAPAN
Postal Code:	564-0063
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15183895
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	KOICHIRO NAKANISHI
SIGNATURE:	/Koichiro Nakanishi/
DATE SIGNED:	06/16/2016
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2	
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DECLARATION AND ASSIGNMENT – WORLDWIDE

Whereas, the undersigned individual(s) (referred to herein as the "INVENTOR(S)") has/have invented:

☒ The attached application to be filed as a United States application or PCT international application, or
☐ United States application or PCT international application number filed on
.....; and, entitled: Solder wire bobbinless coil.

Regarding that application, each of the INVENTOR(S) declares the following:

- The above-identified application was made or authorized to be made by me.
- I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.
- I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the INVENTOR(S) hereby assign, transfer, and set over to:

NIHON SUPERIOR CO., LTD.

having the following address:

1-16-15, Esakacho, Suita-shi, Osaka 564-0063 Japan

(referred to herein as "COMPANY"), its successors, and assigns, the entire right, title, and interest, worldwide, in and to the invention described in the patent application identified above (referred to herein as "INVENTION"), together with said patent application, all divisions, continuations, continuations-in-part, reissues, and extensions thereof, and all Letters Patent (domestic and foreign) that may be granted therefor. Such interest represents the entire ownership of said applications and Letters Patent when granted and is to be owned by COMPANY, its successors, and assigns, or their legal representatives, for the full and entire term for which such Letters Patent may be granted or extended, as fully and entirely as the same would have been enjoyed by the INVENTOR(S) if this assignment had not been made.

In addition, the undersigned INVENTOR(S) each hereby agrees:

1. To sign and execute any further documents that may be necessary or desirable, lawful, and proper in connection with the prosecution of all applications for patent(s) on the INVENTION in the United States, including without limitation said application and all divisions, continuations, continuations-in-part, amendments thereof, and all interference proceedings associated therewith, or otherwise necessary or desirable to secure the title thereto to COMPANY;
2. To execute all papers and documents and to perform all lawful acts that may be necessary in connection with claims to priority or otherwise under the International Convention for the Protection of Industrial Property or similar treaties or agreements;
3. To perform all lawful affirmative acts that may be necessary to obtain the grant of valid and enforceable patents to COMPANY.

The undersigned INVENTOR(S) each hereby authorizes and requests the Commissioner of Patents and Trademarks in the United States to issue any and all Letters Patent resulting from said application, including without limitation any division, continuation, continuation-in-part, or reissue thereof to COMPANY.

The undersigned INVENTOR(S) each hereby grants to Nakanishi IP Associates, LLC the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for the recordation of this document.

IN WITNESS WHEREOF, this Assignment has been executed by each of the undersigned individuals on the date appearing by such individual's signature:

May 20, 2016 Date	1 st Inventor Signature: <u>西村 哲郎</u> Print or Type Name: <u>Tetsuro NISHIMURA</u>
May 20, 2016 Date	2 nd Inventor Signature: <u>福島 裕</u> Print or Type Name: <u>Yutaka FUKUSHIMA</u>
May 20, 2016 Date	3 rd Inventor Signature: <u>吉田 秀樹</u> Print or Type Name: <u>Hideki YOSHIDA</u>
 Date	4 th Inventor Signature: _____ Print or Type Name: _____

This Assignment may be signed before either:
(a) a Notary Public for one of the States of the United States, or (b) two witnesses who sign below:

NOTARY PUBLIC	State of _____ County of _____
	Before me personally appeared: _____ 1 st Inventor
	_____ 2 nd Inventor
	_____ 3 rd Inventor
	_____ 4 th Inventor
	each of whom acknowledged the foregoing instrument to be a free act and deed and also represented that he/she is authorized to execute this Assignment.
	Dated: _____ Notary Public: _____ My commission expires: _____

WITNESSES	May 20, 2016 Date	Signature of Witness: <u>土井 奈月</u> Print or Type Name: <u>Natsuki DOI</u>
	May 20, 2016 Date	Signature of Witness: <u>松本 中かり</u> Print or Type Name: <u>Yukari MATSUMOTO</u>